

HiPSTER® 25

A flexible 25 kW HiPIMS Pulser Unit for the new generation of industrial coatings



Image for reference purpose only.

HiPSTER 25 HiPIMS Pulser

Our new HiPSTER 25 is equipped with cutting-edge transistors made from SiC (Silicon Carbide), unlocking advanced operational modes for superior performance and efficiency.

The HiPSTER BiPolar HiPIMS Units represent the next generation of HiPIMS technology. Expertly designed by leaders in plasma process development and thin-film deposition, these units deliver robust and repeatable HiPIMS processes. With ultra-fast switching technology and enhanced HiPIMS pulse control, the HiPSTER BiPolar series is the ideal solution for developing and executing state-of-the-art HiPIMS applications.

FEATURES

- Bipolar operation provides ion acceleration without the need of substrate biasing
- Stable and robust process control using multiple process parameters
- Can be triggered externally (multiple power supplies)
- New switching technology allowing HiPIMS pulsing frequencies up to 150 kHz
- Tested using a wide range of magnetrons and processes (incl. reactive HiPIMS)
- Add Ionautics' reactive process control for increased stability and higher deposition rate

APPLICATIONS

- **Hard coatings:** Smoother and denser elemental as well as reactively deposited compound coatings, which result in increased hardness, reduced corrosion, and less friction
- **Optical coatings:** Increased optical properties through smoother interfaces and denser structures
- **Diffusion barriers:** Better performance through increased coating density
- **Electrical coatings:** Improved conductivity enabling reduced coating thickness and reduced heat load. Also increased isolation in the case of insulators can be obtained
- **3-D coatings:** Uniform film coverage on complex shaped substrates

Output Specifications

Output Average Power: ≤ 25 kW

Regulation Modes: Voltage
Current
Power
Pulse Current
Pulse charge

Arc control-reaction time: < 2 μ s

Input Specifications

Input Voltage AC: 1 phase + N, 100–240 VAC, 50/60 Hz

Input Current at 230 V: 0.3 A

DC Charging Input: 1 000 V max, fully floating ± 1 kV from ground

Remote communication: RS 232, RS 485, EtherCat, Profibus

Unipolar Mode (negative pulse)

Output Peak Voltage: $\leq 1\,000$ V

Output Peak Current: $\leq 1\,500$ A

Pulse Duration: 3.5 μ s to 1 000 μ s

Pulse Frequency 50 to 10 000 Hz

Environmental Specifications:

Cooling: Water Cooling

Dimensions:

Size: 19" rack (3U)
135 mm (H) X 483 mm (W) X 510 mm (D)

Weight: 25 Kg

Optional Bipolar Mode (positive pulse)

Output Peak Voltage: ≤ 250 V

Pulse Duration: $\leq 1\,500$ μ s
(to be confirmed)

Pulse Delay: 3.5 μ s to 1 000 μ s
(to be confirmed)

Optional Pulsed Mode DC

Pulse Frequency: up to 150 kHz
(to be confirmed)



DANIEL LUNDIN
Associate Professor

Expert in the field of HiPIMS processes and magnetron sputtering with focus on deposition processes and process characterization.



ULF HELMERSSON
Professor

Expert in the field of physical vapor deposition, such as magnetron sputtering and HiPIMS processes with focus on material science.



RAFAEL SANCHEZ
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In charge of sales and marketing worldwide. 10 years of experience in thin film deposition using magnetron sputtering.

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CONTACT>>>>